## **DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "METHODS FOR POLISHING A SEMICONDUCTOR TOPOGRAPHY," the specification of which.

is attached hereto. was filed on and was amended on	as Application Se	rial No						
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.								
I acknowledge the duty to disc patentability of the subject matter claimed	lose to the Patent and Tradem I in this application, as "matern	ark Office all information ality" is defined in 37 C.F.	known to me to R. § 1.56.	be material to				
I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate listed below, or under § 365(a) of any PCT international application listed below designating least one country other than the United States of America, and have identified below any foreign application for patent or inventor's certificate, or of any PCT international application, having a filing date before that of the application on which priority is claimed.								
Prior Foreign Application No.	Country	Filing Date (mm/dd/yy)	<u>Priority</u> <u>Claimed</u>	Cert. copy Attached				
N/A			****					
I hereby claim the benefit under	35 U.S.C. § 119(e) of any Un	ted States provisional appl	ication(s) listed	below.				
Provisional Application No.	Filing Date (mm/dd/yy)							
N/A								
I hereby claim the benefit under any PCT international application listed each of the claims of this application is a provided by the first paragraph of 35 U.S. to the patentability of the subject matter cavailable between the filing date of the propagation of	below designating the United not disclosed in the prior United. § 112, I acknowledge the delaimed in this application, as "lor application and the national Filing Date	States of America, and, in a states or PCT international ty to disclose all informationateriality" is defined in 3	asofar as the submal application on known to make 7 C.F.R. § 1.56, g date of this ap	bject matter of in the manner to be material which became plication.				
	(mm/dd/yy)							
N/A								

The Assignee hereby revokes any previous Powers of Attorney and appoints Andrew D. Fortney, Reg. No. 34,600 and Laura Lee M. Engurasoff, Reg. No. 42,886 of Cypress Semiconductor Corporation; and Kevin L. Daffer, Reg. No. 34,146; B. Noel Kıvlın, Reg. No. 33,929; Eric B. Meyertons, Reg. No. 34,876; Gentry E. Crook, Reg. No. 44,633; and Mollie E. Hamel, Reg. No. 48,405 of the firm of Conley, Rose & Tayon, as attorney or agent for so long as they remain with such company or firm, with full power of substitution and revocation, to prosecute the application, to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, and to receive the Letters Patent.

Please direct all communications to:

Kevin L. Daffer Conley, Rose & Tayon, P.C. P.O. Box 398 Austin, Texas 78767-0398 Phone: (512) 476-1400

I hereby declare that all statements made herein of my own knowledge are true and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's Full Name:	Andrey Zagrebelny						
Inventor's Signature:	And very Lagret	elny	Date:	12/18	1/0/		
City and State (or Foreign	Country) of Residence:	Eagan, MN	Cıtizens	ship:	Ukraine		
Post Office and Residence	Address:	1696 Galway Lane, Eagan, MN 55122					
(Include number, street name, city, state and zip code)							